



**COPY OF PAPERS  
ORIGINALLY FILED**

PATENT

I hereby certify that on the date specified below, this correspondence is being deposited with the United States Postal Service as first-class mail in an envelope addressed to Box Non-Fee Amendment, Commissioner of Patents, Washington, DC 20231.

Date

Date \_\_\_\_\_

Ayesha S. Wilks

10/13

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

S-1-02

Applicant : Vishnu K. Agarwal

Attorney Docket No.: 501082.02 (98-0616.01)

Serial No. : 09/652,994

Group Art Unit : 2815

Filed : August 31, 2000

Examiner : Jesse A. Fenty

**Title : DEVICE AND METHOD FOR PROTECTING AGAINST OXIDATION OF A CONDUCTIVE LAYER IN SAID DEVICE**

Box Non-Fee Amendment  
Commissioner of Patents  
Washington, DC 20231

## AMENDMENT

Siri:

Please amend the above-captioned patent application as follows:

### In the Claims:

Please amend claims 73-75 as follows:

73. (Amended) An in-process device, comprising:  
a substrate; and  
a conductive layer over the substrate, the conductive layer being  
selection consisting of diborane, phosphine, methylsilane, hexamethydisilane,  
silazane, HCL, boron trichloride, and combinations thereof to reduce an ability of  
the layer to associate with oxygen.

74. (Amended) The in-process device of claim 73, wherein the conductive layer comprises tungsten nitride.

RECEIVED  
MAY 25 2002  
TECHNOLOGY CENTER 2800